COMPLIANT

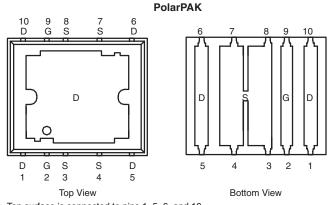


New Product

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
		I _D (A) ^a				
V _{DS} (V)	r _{DS(on)} (Ω)	Silicon Limit	Package Limit	Q _g (Typ)		
30	0.0042 at V _{GS} = 10 V	120	50	33 nC		
30	0.0048 at $V_{GS} = 4.5 \text{ V}$	112	50	33 110		

Package Drawing



Top surface is connected to pins 1, 5, 6, and 10

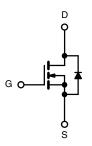
Ordering Information: SiE830DF-T1-E3 (Lead (Pb)-free)

FEATURES

- Extremely Low $\,{\rm Q}_{\rm gd}\,{\rm WFET}^{\rm @}\,{\rm Technology}$ for Low Switching Losses
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK® Package for **Double-Sided Cooling**
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{gd}/Q_{gs} Ratio Helps Prevent Shoot-Through 100 % R_g and UIS Tested

APPLICATIONS

- **VRM**
- Point-of-Load
- Synchronous Rectification



N-Channel MOSFET For Related Documents

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	± 12		
-	T _C = 25 °C		120 (Silicon Limit)		
	10-23 0		50 ^a (Package Limit)		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	50 ^a		
	T _A = 25 °C		27 ^{b, c}	Α	
	T _A = 70 °C		21.6 ^{b, c}	^	
Pulsed Drain Current		I _{DM}	80		
	T _C = 25 °C		50 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	l _s	4.3 ^{b, c}		
Single Pulse Avalanche Current $T_C = 25 ^{\circ}\text{C}$		I _{AS}	30	Α	
Avalanche Energy	1C - 23 0	E _{AS}	45	mJ	
	T _C = 25 °C		104		
Maximum Power Dissipation	T _C = 70 °C	P _D	66	w	
	T _A = 25 °C] 'b [5.2 ^{b, c}		
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 50 to 150	°C	
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260		

Notes:

- a. Package limited is 50 A.b. Surface Mounted on 1" x 1" FR4 board.
- d. See Solder Profile (http://www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 sec	R _{thJA}	20	24		
Maximum Junction-to-Case (Drain Top) ^a		R _{thJC} (Drain)	1	1.2	°C/W	
Maximum Junction-to-Case (Source)a, c	Steady State	R _{thJC} (Source)	2.8	3.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
 b. Maximum under Steady State conditions is 68 °C/W.
 c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static				•			
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			30		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 4.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6	1.4	2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 16 A		0.0035	0.0042		
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0039	0.0048	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 16 A		95		S	
Dynamic ^b							
Input Capacitance	C _{iss}			3000		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		650			
Reverse Transfer Capacitance	C _{rss}			220			
Total Gate Charge	Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$ $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		75	115	nC	
				33	50		
Gate-Source Charge	Q_{gs}			11			
Gate-Drain Charge	Q _{gd}			5.1			
Gate Resistance	R_g	f = 1 MHz		1.0	1.5	Ω	
Turn-on Delay Time	t _{d(on)}			35	55		
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω		105	160		
Turn-Off Delay Time	t _{d(off)}			70	105		
Fall Time	t _f			95	145		
Turn-on Delay Time	t _{d(on)}			15	25	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		40	60	110	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		45	70		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			50	А	
Pulse Diode Forward Current ^a	I _{SM}				80	^	
Body Diode Voltage	V_{SD}	I _S = 10 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			40	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs, T _{.I} = 25 °C		40	60	nC	
Reverse Recovery Fall Time	t _a	i _F = 10 A, α/αι = 100 A/μs, 1 _J = 25 C		22		nc	
Reverse Recovery Rise Time	t _b			18		ns	

Notes:

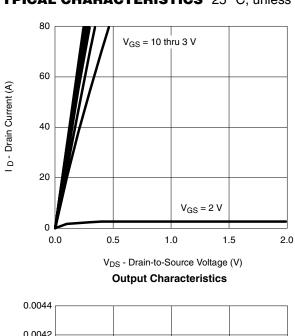
- a. Pulse test; pulse width \le 300 μ s, duty cycle \le 2 % b. Guaranteed by design, not subject to production testing.

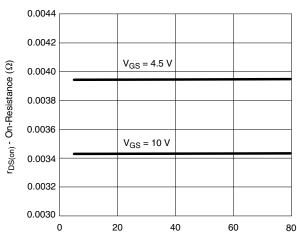
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



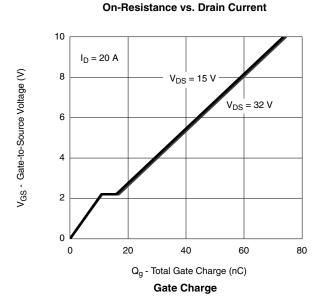


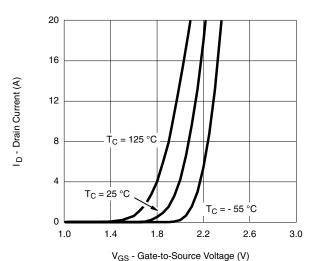
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

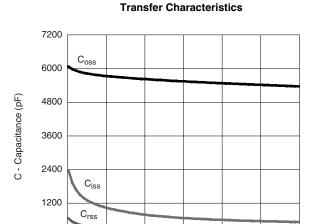




ID - Drain Current (A)







0

0

5

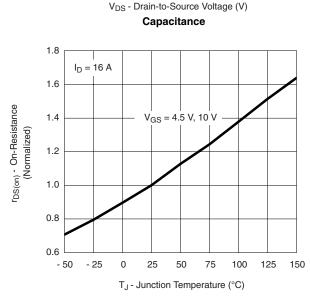
10

15

20

25

30

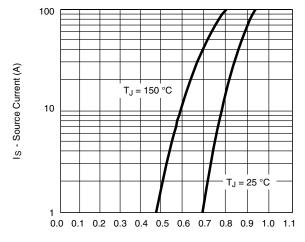


On-Resistance vs. Junction Temperature

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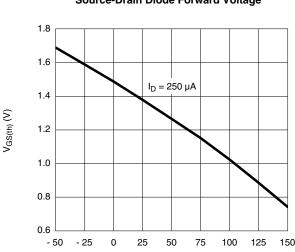
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage



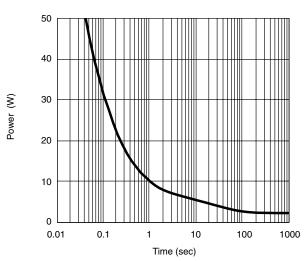
T_J - Temperature (°C)

Threshold Voltage

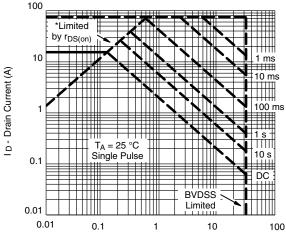
0.010 I_D = 16 A $r_{DS(on)}$ - Drain-to-Source On-Resistance (Ω) 0.009 0.008 0.007 T_A = 125 °C 0.006 0.005 $T_A = 25$ °C 0.004 0.003 0.002 0 4 8 10

V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



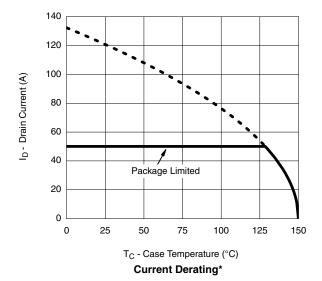
$$\begin{split} &V_{DS}\text{ - Drain-to-Source Voltage (V)}\\ ^*V_{GS} > & \text{minimum }V_{GS} \text{ at which }r_{DS(on)} \text{ is specified} \end{split}$$

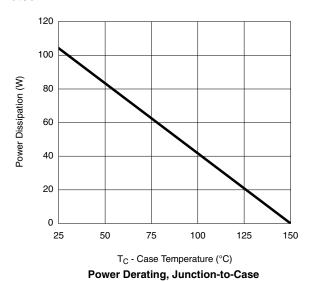
Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



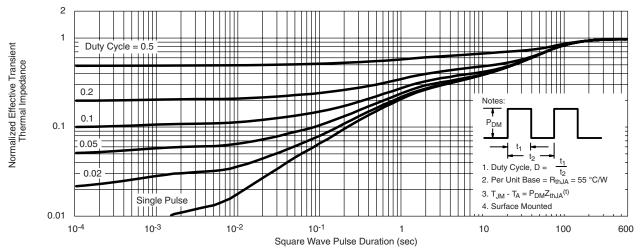


 $^{^{\}star}$ The power dissipation P_D is based on T_{J(max)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

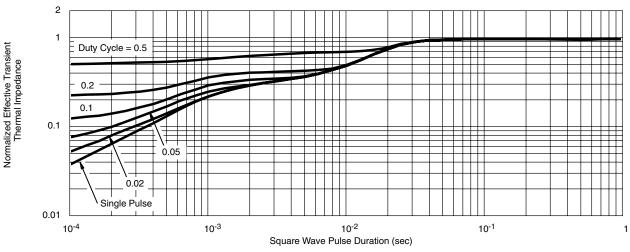
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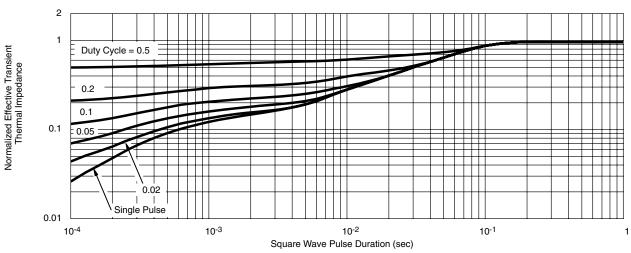
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

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